

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

**In re Application of:**

David R. Hembree

**Serial No.:** 10/624,332

**Filed:** July 22, 2003

**For:** CHIP ON BOARD AND HEAT SINK  
ATTACHMENT METHODS

**Confirmation No.:** 6977

**Examiner:** C. Lee

**Group Art Unit:** 2812

**Attorney Docket No.:** 2269-3592.8US  
(97-0321.08/US)

**Notice of Allowance Mailed:**

February 21, 2007

**VIA ELECTRONIC FILING**  
**May 16, 2007**

**AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)**

Mail Stop ISSUE FEE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

**Amendments to the claims** are set forth in the listing of the claims that begins on page 2  
of this paper; and

**Remarks** start at page 5 of this paper.